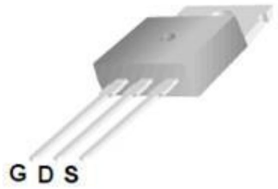
P106AAT

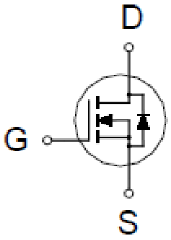
N-Channel Enhancement Mode MOSFET

PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
65V	10mΩ @V_{GS} = 10V	74A



TO-220



ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		V_{DS}	65	V
Gate-Source Voltage		V_{GS}	±20	
Continuous Drain Current[2]	T_C = 25 °C	I_D	74	A
	T_C = 100 °C		38	
Pulsed Drain Current[1,2]		I_{DM}	180	
Avalanche Current		I_{AS}	65	
Avalanche Energy	L = 0.1mH	E_{AS}	215	mJ
Power Dissipation	T_C = 25 °C	P_D	104	W
	T_C = 100 °C		46	
Junction & Storage Temperature Range		T_J, T_{STG}	-55 to 150	°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	$R_{\theta JC}$		1.2	°C / W

[1] Pulse width limited by maximum junction temperature.

[2] Limited only by maximum temperature allowed.

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ELECTRICAL CHARACTERISTICS (T_J = 25 °C, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS} = 0V, I_D = 250µA	65			V
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250µA	2.0	2.8	4.0	
Gate-Body Leakage	I_{GSS}	V_{DS} = 0V, V_{GS} = ±20V			±100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 52V, V_{GS} = 0V			1	µA
		V_{DS} = 50V, V_{GS} = 0V , T_J = 100 °C			10	
Drain-Source On-State	$R_{DS(ON)}$	V_{GS} = 10V, I_D = 42A		8.2	10	mΩ
Forward Transconductance[1]	g_{fs}	V_{DS} = 10V, I_D = 42A		43		S
DYNAMIC						
Input Capacitance	C_{iss}	V_{GS} = 0V, V_{DS} = 25V, f = 1MHz		5010		pF
Output Capacitance	C_{oss}			351		
Reverse Transfer Capacitance	C_{rss}			323		
Gate Resistance	R_g	V_{GS} = 0V, V_{DS} = 0V, f = 1MHz		0.8		Ω
Total Gate Charge[2]	Q_g	V_{DS} = 0.5$V_{(BR)DSS}$, V_{GS} = 10V, I_D = 42A		119		nC
Gate-Source Charge[2]	Q_{gs}			30		
Gate-Drain Charge[2]	Q_{gd}			50		
Turn-On Delay Time[2]	$t_{d(on)}$	V_{DS} = 33V, I_D ≅ 42A, V_{GS} = 10V, R_{GEN} = 6Ω		30		nS
Rise Time[2]	t_r			39		
Turn-Off Delay Time[2]	$t_{d(off)}$			80		
Fall Time[2]	t_f			24		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_J = 25 °C)						
Continuous Current	I_S				74	A
Forward Voltage[1]	V_{SD}	I_F = 42A, V_{GS} = 0V			1.3	V
Reverse Recovery Time	t_{rr}	I_F = 42A, dI_F/dt = 100A / µS		53		nS
Reverse Recovery Charge	Q_{rr}			143		nC

[1] Pulse test : Pulse Width ≤ 300 µsec, Duty Cycle ≤ 2%.

[2] Independent of operating temperature.

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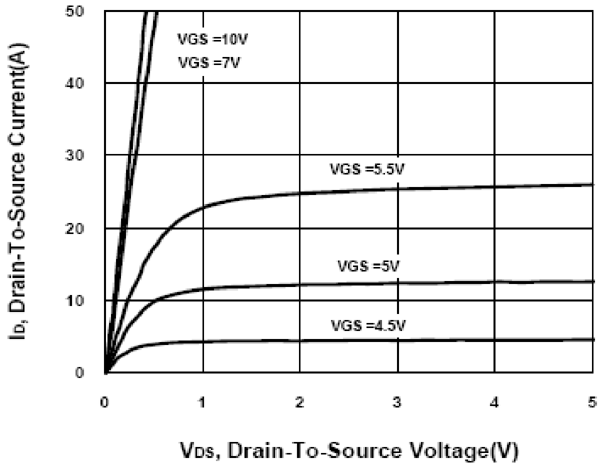
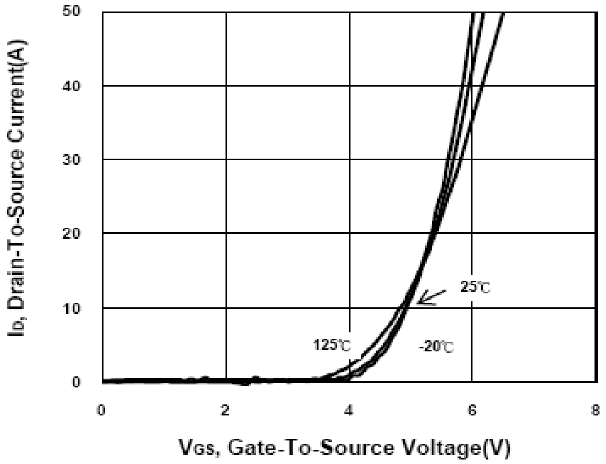
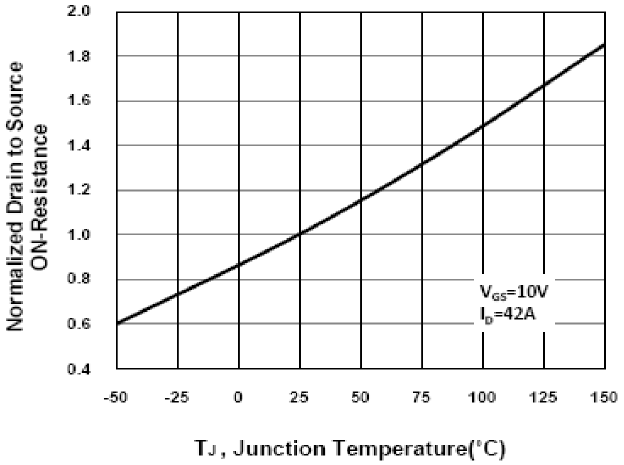
Output Characteristics



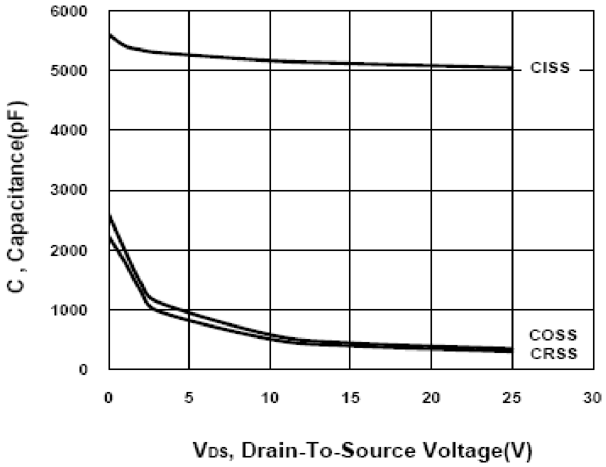
Transfer Characteristics



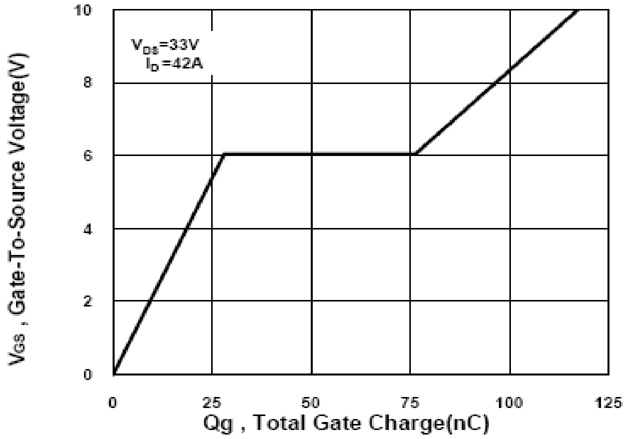
On-Resistance VS Temperature



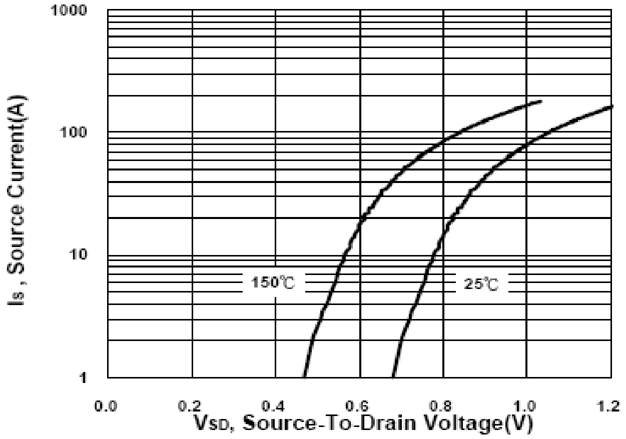
Capacitance Characteristic



Gate charge Characteristics



Source-Drain Diode Forward Voltage



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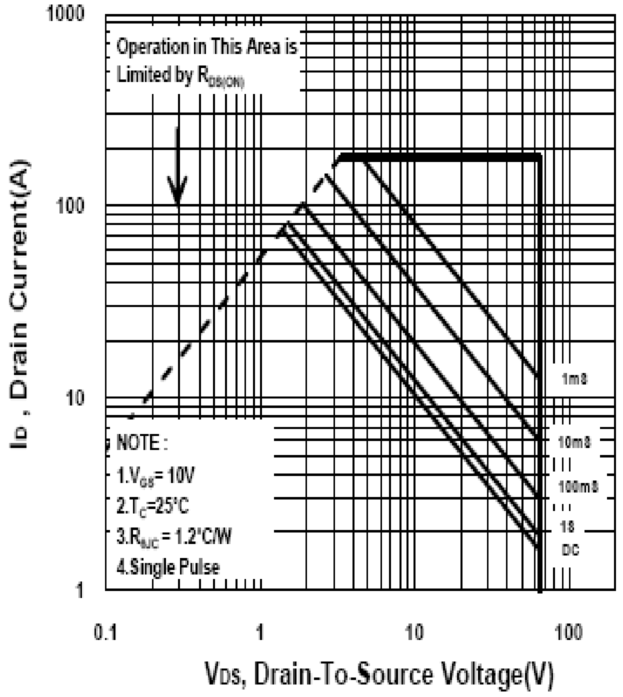
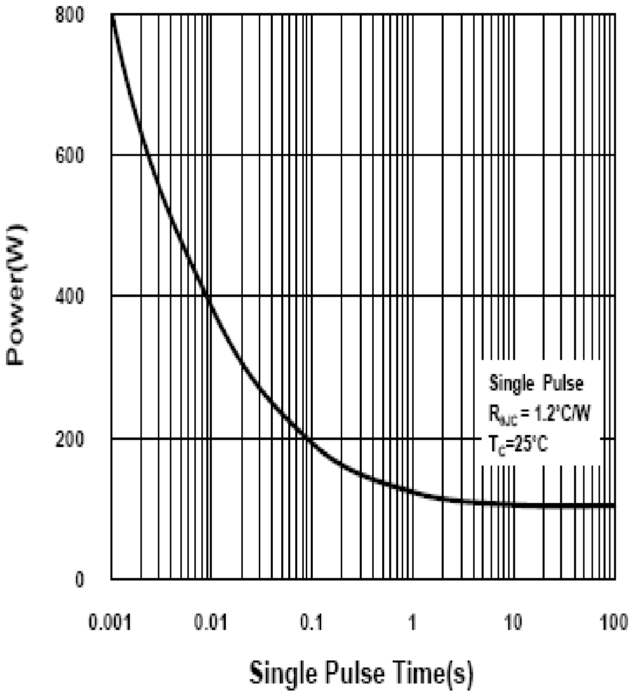
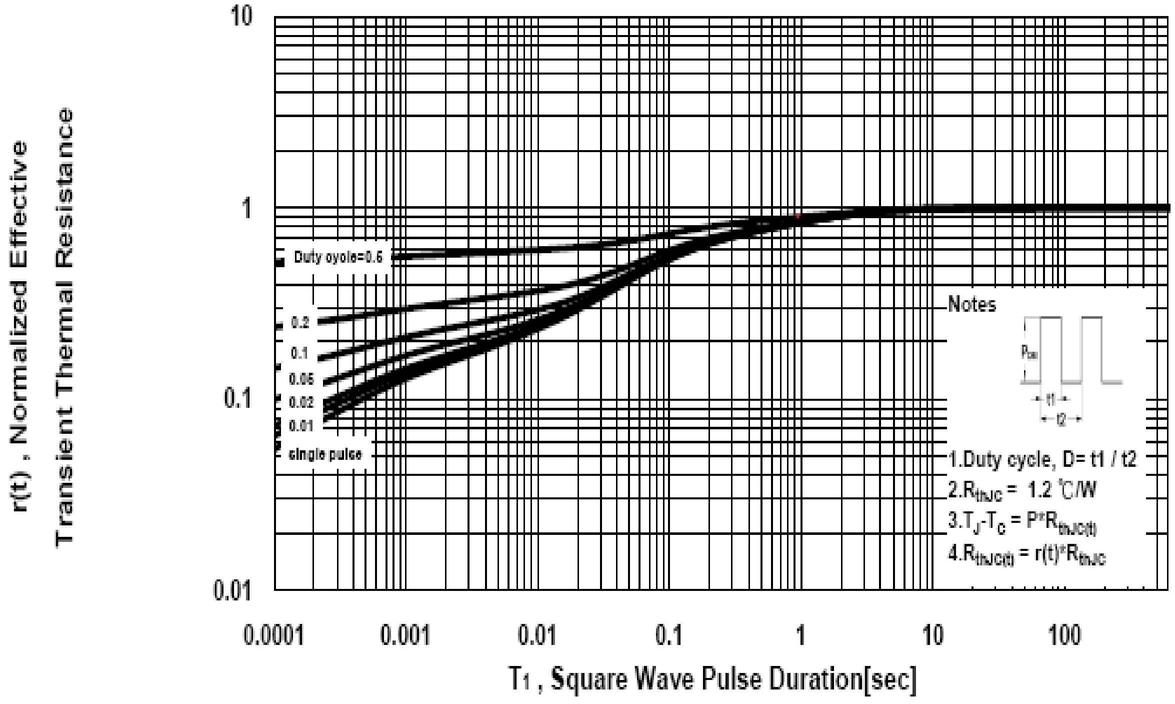

Safe Operating Area


Single Pulse Maximum Power Dissipation


Transient Thermal Response Curve

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Package Dimension

TO-220 (3-Lead) MECHANICAL DATA

Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	9.652	10.16	11.5	H	2.04	2.54	3.04
B	2.54	2.79	3.048	I	1.15	1.52	1.778
C	17.3		22.86	J	3.556	4.57	4.826
D	26.924	29.03	31.242	K	0.508	1.3	1.45
E	14.224	15.45	16.510	L	1.89	2.69	3.09
F	8.382	9.20	9.40	M	0.34	0.5	0.6
G	0.381	0.81	1.016	N